LCM Specification

Preliminary specification

□Final Specification

Project N 项目编号	TFT-H043A12SVILT4R40			R40			
Custome 客户名称	er K		2				
Module N 客户型号	O.						
Product typ 产品内容	pe c	TF1 800 4.3'	TFT LCD Module 800 x 3RGB x 480 Dots 4.3"TFT LCD				
Signature by customer:							
客户确认签章:							
□Trial p	production		□Mass pro	oduction			
编制	电子审核		结构审核	批	准		
YL.Liu							

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Shenzhen Hot Display Technology Co.,Ltd

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ПИНТОН

1. General Feature:

ltem	Standard Value	Unit	
Display Size	4.3"		
Number of Pixels	800(H)x3(RGB)*480(V)		
Active Area	95.04(H) *53.86(V)	mm	
	105.50(H) ×67.20(V)× 2.95(D) <tft></tft>		
Outline Dimension	105.50(H) ×67.20(V)× 4.15(D) <tft+rtp></tft+rtp>	mm	
Viewing Direction	FULL O'Clock	-	
Interface	MCU 8/16,SPI 3L/4L,IIC	-	
TFT Driver IC	ST7262+HOT7381	-	
TFT Driver Condition	VCI=3.3V	V	
Backlight	White LED	-	
Touch Panel	Resistive Touch	-	
CTP Driver IC			
CTP Driver Condition			
TFT <mark>Opera</mark> tion Temperature	-30~85	°C	
TFT Storage Temperature	-30~85	°C	

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2.Outline Dimensions



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3. Pin Description

3.1 <u>Pin Description</u>

Pin NO.	Symbol	Description		
1,2	LED_K	LED Cathode		
3,4	LED_A	LED Anode(+16V/40mA)		
5,6	GND	Ground		
7,8	VCI	Analog Power(3.0 ~ 3.6 V,3.3V)		
9-11	PS[2-0]	MCU interface settings.Please refer to Table 3-3 "MCU Wiring Diagram" description.		
12	RESX	Reset input signal When RESX = 0 and maintain the length of 256 clock cycles, HOT7381 will generate a reset action.		
13	CS	Chip select signal. If the MCU interface is set to the serial mode, this pin can be set to GPIB [0], internal pull-up resistor		
14	RD	Read control signal 8080 in parallel mode, this pin is the signal RD #, RD # = 0, representative of the MCU HOT7381 Zhong gets or read data row is the status read cycle. In the 6800 parallel mode, this pin is the EN signal, $EN = 1$, which means that the MCU's control of HOT7381 is in the Enable cycle. If the MCU interface is set to the serial mode, this pin can be set to GPIB [0], internal pull-up resistor		
15	WR	Write control signal In the 8080 parallel port mode, this pin is the WR# signal, WR# = 0, which represents the MCU writes commands to HOT7381 or data write cycles. In the 6800 parallel port mode, this pin is the RW# signal, RW# = 1, which means that the MCU is reading data or status reading cycle of HOT7381. RW# = 0, which means MCU writes commands or data write cycles to HOT7381 If the MCU interface is set to the serial mode, this pin can be set to GPIB [0], internal pull-up resistor		
16	RS	Command or data selection signal RS = 0, which means that the MCU reads the status of the HOT7381 or commands the write cycle. RS = 1, which means that the MCU reads or writes data to the HOT7381 . If the MCU interface is set to the serial mode, this pin can be set to GPIB [0], internal pull-up resistor		
17	WAIT	Waiting for output signal When the MCU performs read and write control on HOT7381, if HOT7381 is busy, it will change WAIT# to a low level to inform the MCU to enter the waiting period.		
Continued				
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Pin NO.	Symbol	Description			
18-33	DB[0-15]	MCU data bus When the MCU connection interface is set to parallel mode, these data buses serve as the data transmission interface with the MCU. DB[15:8] can be set as a GPIO interface in 8-bit parallel mode. DB[7:0] are also shared pins. If set to serial port mode, these data buses will be used as serial port signals. Please refer to Table 3-2 "MCU serial port signal" description.			
34	INT	Interrupt output signal When the set interrupt condition occurs, this pin becomes a low level, which is used to generate an interrupt output to inform the MCU.			
35	NC	Open this pin.			
36	GND	Ground			
37	RTP_XR	Resistive TP function pin. If not used, let this pin open.			
38	RTP_YD	Resistive TP function pin. If not used, let this pin open.			
39	RTP_XL	Resistive TP function pin. If not used, let this pin open.			
40 RTP_YU Resistive TP function pin.If not used, let this pin open.					
END					

3.2 MCU serial port signal

Dim	808	30 I/F	680	0 I/F	CDI 21	SDI 4I	ИС	
PIII	8 Bit	16 Bit	8 Bit	16 Bit	SPI 3L	SPI 4L	пс	
DB[15-8]		DB[15-8]		DB[15-8]	GPIOA[0:7]	GPIOA[0:7]	GPIOA[0:7]	
DB7	DB7	DB7	DB7	DB7	SCLK	SCLK	SCLK	
DB6	DB6	DB6	DB6	DB6	接地	SDI	I2C_SDA	
DB5	DB5	DB5	DB5	DB5	SD	SDO	I2CA[5]	
DB4	DB4	DB4	DB4	DB4	SCS	SCS	I2CA[4]	
DB[3-0]	DB[3-0]	DB[3-0]	DB[3-0]	DB[3-0]	接地	接地	I2CA[3:0]	
CS	CS	CS	CS	CS	GPIB[0]	GPIB[0]	GPIB[0]	
RD	RD	RD	EN	EN	GPIB[1]	GPIB[1]	GPIB[1]	
WR	WR	WR	RW	RW	GPIB[2]	GPIB[2]	GPIB[2]	
RS	RS	RS	A0	A0	GPIB[3]	GPIB[3]	GPIB[3]	
INT	INT	INT	INT	INT	INT	INT	INT	
WAIT	WAIT	WAIT	WAIT	WAIT				

NOTE1: When using the parallel port mode, the choice of 8-bit or 16-bit data transmission is determined by the bit0 Of the register REG[01h]. If bit0=0, it is set to 8bit data bus, if bit0=1, it is set to 16bit Data Bus.

NOTE2:GPIOA[7:0] are general-purpose I/Os. These pins are shared with DB[15:8]. GPIOA can be used only when the MCU is set to 8-bit parallel mode or serial port mode. The output mode of these pins can be set via registers.
NOTE3:The input signal of GPIB[3:0] shares pins with {RS, WR, RD, CS }. GPIB[3:0] only provides read function,

and can be used only when MCU is set to serial port mode. The output mode of these pins can be set via registers.

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НОТНМІ

3.3 <u>Wiring Diagram</u>



PS2	PS1	PS0	MCU Interface
0	0	Х	8080 8/16 bit
0	1	Х	6800 8/16 bit
1	0	0	SPI 3L
1	0	1	SPI 4L
1	1	Х	IIC

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4. Electrical Characteristics

<u>4-1 TFT LCD Module Operating Conditions</u>

Item	Symbol	Condition	Min	Туре	Max	Uint
Interface logic circuits	IOVCC	-	-	-	-	V
Analog Power supply	VCI	-	3.0	3.3	3.6	V
TFT Gate on voltage	VGH	-	-	13.0	-	V
TFT Gate off voltage	VGL	-	-	-10.5	-	V

<u>4-2 LED back light specification (pera chip)</u>

Item	Symbol	Condition	Min	Туре	Max	Uint
Forward voltage	Vt	lf=20mA	15.0	16.0	17.0	V
Forward current	lpn	/1-chip	/-	40	-	mA
Luminance(With LCD)	Lv	lf=40mA	-	600	-	cd/m²
Luminous color	White					

4-3 CTP Operating Conditions

Item	Symbol	Condition	Min	Туре	Max	Uint
Power Supply Voltages	VDD	-	2.8	3.30	3.60	V
I/O Digital Voltage	IOVDD	-	2.8	3.30	3.60	V

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5. OPTICAL SPECIFICATION

5.1 Overview

The test of Optical specifications shall be measured in a dark room (ambient luminance 1lux and temperature = 25 2° C) with the equipment of Luminance meter system (Goniometer system and TOPCON BM-5) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0 . The center of the measuring spot on the Display surface shall stay fixed. The backlight should be operating for 30 minutes prior to measurement.

Parar	neter	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
N	Horizontal	ΘL		-	80	-	Deg.	
Angle	Tionzontar	ΘR	CR>10	-	80	0-	Deg.	Note 1
Range	Vertical	ΘU		-	80	1-	Deg.	
	Vertieur	ΘD		-	80		Deg.	
Contras	st ratio	CR	$\Theta = 0^{\circ}$	1	1200	-		Note2
Color (Gamut	CG		45	50	-	%	
White Chr	White Chromoticity			-	(0.311)	-		
	omunenty	Wy	\sim		(0.338)	-		
	Red	Rx			-	-		
	ittu	Ry	$\Theta = 0^{\circ}$	-	-	-		Note4
Reproduction	Green	Gx		-	-	-		(Based
of color	Green	Gy		-	-	-		on C
	Plue			-	-	-		Light)
Diac		By		-	-	-		
Respons	se Time	Tr + Tf	$\Theta = 0^{\circ}$		30		me	Note5
(Rising + Falling)			Ta=25℃	-	50	-	1115	INDICS
Transmittance(with Polarizer)	Tr		-	(4.6)	-	%	Note3

5.2 Optical Specifications

Note:

1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o' clock direction and the vertical or 6, 12 o' clock direction with respect to the optical axis which is normal to the LCD surface (see FIGURE 1).

2.Contrast measurements shall be made at viewing angle of $\Theta = 0$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black)

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state . (see FIGUR 1) Luminance Contrast Ratio (CR) is defined mathematically.

CR= Luminance when displaying a white raster Luminance when displaying a black raster

3. Transmittance is the Value without APF and without CG.

ПНОТНМІ

4. The color chromaticity coordinates specified in the above table shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

5. The electro-optical response time measurements shall be made as FIGURE 2 by switching the

"data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr, and 90% to 10% is Tf.

Figure1 Measurement Set Up



Figure2 Response Time Testing





Course la sel	Devenueteur	Rating		11-14	Mada		
Symbol	Parameter	Min.	Max.	Unit	Note		
T _{CYC8}	Cycle Time	50		ns			
T _{CC8}	Strobe Pulse Width	20	<u>555</u> 5	ns			
T _{AS8}	Address Setup Time	0		ns			
T _{AH8}	Address Hold Time	10		ns	tc is one system clock		
T _{DS8}	Data Setup Time	20		ns	$tc = 1/SYS_CLK$		
T _{DH8}	Data Hold Time	10		ns			
T _{ACC8}	Data Output Access Time	0	20	ns			
T _{OH8}	Data Output Hold Time	0	20	ns			

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符号	参数	Rating		曲法	28 D B
		Min.	Max.	1111	107. 109
T _{CYC6}	Cycle Time	50		ns	tc is one system clock period: tc = 1/SYS_CLK
T_{EW}	Strobe Pulse Width	20	0	ns	
T _{AW6}	Address Setup Time	0		ns	
T _{AH6}	Address Hold Time	10		ns	
T_{DS6}	Data Setup Time	20		ns	
T _{DH6}	Data Hold Time	10		ns	
T _{ACC6}	Data Output Access Time	0	20	ns	
T _{OH6}	Data Output Hold Time	0	20	ns	

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Host through the host interface to access HOT7381"s Registers and Display Memory. HOT381 has one Status Register and 256 Instruction Registers (i.e. .REG[00h] ~ REG[FF]). The access procedure are as following:

Register Write:

1. Address Write: Write the Register"s Address. For example, 00h i.e. REG[00h], 01h i.e.

REG[01h], 02h i.e. REG[02h]

2. Data Write: Write Data to the Register

Register Read:

- 1. Address Write: Write the Register"s Address
- 2. Data Write: Read Data from the Register

Displays Memory (Display RAM) is where the TFT screen image data is stored,. Host through interface

and write data into Display RAM. The procedure of access Display RAM is as following:

Display RAM Write:

- 1. Set the Active Window Registers before writing any image data.
- 2. Perform an register write to Graphic R/W Position Register 0, REG[5Fh]).
- 3. Repeat step 2 until setup all the Active Window & Graphic R/W Position Coordinates.
- 4. Perform an address write to point to Memory Data Port Register (REG[04h])

5. Perform data writes to fill the window. Each write to the Memory Data Port will auto-increment the internal memory address.

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Status Register Read:

1. Host drive SCS#(Low) and SCLK(SPI Clock).

2. Host drive A0(Low), then drive RW#(High).

3. HOT381 will drive the Data of Status Register ($b7 \sim b0$) at 9 th ~ 16 th Clock. Then Host will get the content of Status Register.

Write Register's Address:

1. Host drive SCS#(Low) and SCLK.

2. Host drive A0(Low), then drive RW#(Low).

3. Host drive the Register's Address ($b0 \sim b7$) at 9 th ~ 16 th Clock to HOT381.

Write Data to Register or Memory:

1. Host drive SCS#(Low) and SCLK.

2. Host drive A0(High), then drive RW#(Low).

3. Host drive the Data at 9 th ~ 16 th Clock to HOT381. i.e. Data will be stored in Register or Memory.

Read Register's Data:

1. Host drive SCS#(Low) and SCLK.

2. Host drive A0(High), then drive RW#(High).

3. HOT381 will drive the Data of Register at 9 th \sim 16 th Clock. Then Host will get the content of Register.

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RW#(Low), that"s means Host write Register's Address. When Host drive A0(High), then RW#(Low) that"s means Host write data to Register or Display RAM.

The following Timing diagram is the Read Cycle of 4-Wires SPI. When Host drive A0(Low) and RW#(High), that"s means Host want to read the data of Status Register. HOT381 will drive the Data of Status Register ($b7 \sim b0$) at 9 th ~ 16 th Clock. Then Host will get the data of Status Register. When Host drive A0(High), then RW#(High) that"s means Host want to read the data of Command Register. HOT381 will drive the Data of Command Register ($b7 \sim b0$) at 9 th ~ 16 th Clock for Host. Of course, Host will get the content of Command Register.





6-4 IIC Interface

The serial I2C interface is also almost same as 3-Wires SPI interface. But I2C interface only need 2 wires for data transfer. The following is the application circuit of I2C interface. Signals I2CA[5:0] are used to setup HOT381"s Device ID, and to avoid confuse with other"s I2C device. In this example circuit, I2CA[5:3] connect to VDD, and if all DIP Switch are "ON" state, then I2C Device ID is 111000b. i.e. 38h. Therefore if Host drive I2C timing with "111000b" Device ID, then HOT381 will communicate in the I2C cycle time with Host.



At first, Host has to know the Device ID of the I2C device. Then release the Device ID's data in the five clocks of beginning. the Device ID data is 111000. The definition of A0 and RW# are same as SPI interface. When Host release A0(High) and RW#(Low), that means Host will write data(b7 ~ b0, at 10th ~ 17th Clock) to Command Register or Display RAM. If Host release A0(High) and RW#(High), that means Host want to read date from Command Register. HOT381 will release the content(b7 ~b0) of Command Register on 10th ~ 17th Clock. If Host release A0(Low) And RW#(High), that means Host want to read Status Data. HOT381 will release the Status Data(B7~ B0) on 10th ~ 17th Clock. Host will get the data of HOT381"s Status Register.

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7. RELIABILITY TEST

7-1 Temperature and Humidity

TEST ITEMS	CONDITIONS	NOTE
High Temperature Storage	Ta=+85 o C, 240hrs	
Low Temperature Storage	Ta=-30 o C, 240hrs	
High Temperature Operation	Ta=+85 o C, 240hrs	
Low Temperature Operation	Ta=-30 o C, 240hrs	
High Temperature and High		
Humidity	Ta=+60 o C, 90%RH, 240hrs	
(Operating)		

Note: (1) All tests above are practiced at module type.

(2) There is no display function NG issue occurred, all the cosmetic specification is judged before the reliability stress.



(a) Test Pattern (chess board Pattern)

(b) Gray Pattern

7-2 Shock and Vibration

ITEMS	CONDITIONS
Packing Shock	Shock level:980m/s ²
(Non-Operation)	Waveform:1/2 Sine wave,6msec
	• $\pm X$, $\pm Y \pm Z$, each axis 1 times
	Frequency range:8-33.3HZ
Packing Vibration	Stoke:1.0mm
(Non-Operation)	Sweep: 10Hz-50Hz
	x,y,z 2 hours for each direction

7-3 Electrostatic Discharge

TEST ITEM	CONDITIONS
ESD	150pF,330 Ω , Contact \pm 4KV,Air: \pm 8KV.Note 1
(Non-operation)	200pF,0 Ω , \pm 200V Contact test.Note 2

Note:Measure Point:

- 1.LCD glass and metal bezel
- 2.IF connector pins

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8.HANDDLING & CAUTIONS

8-1 Caution For Operation

ПОТНИ

•Since the LCM is made of glass, do not apply strong mechanical impact or static load onto it.Handling with care since shock, vibration, and careless handling may seriously affect the product.If it falls from a high place or receives a strong shock, the glass maybe broken.

◆It is indispensable to drive the LCM within the specified voltage limit since the higher voltage than the limit causes LCM's life shorter. An electro-chemical reaction due to DC causes undesirable deterioration of the LCM so that the use of DC drive should avoid.

♦Do not connect or disconnect the LCM to or from the system when power is on.

Never use the LCM under abnormal conditions of high temperature and high humidity.

♦When expose to drastic fluctuation of temperature(hot to cold or cold to hot), the LCM may be affected; specifically, drastic temperature fluctuation from cold to hot, produces dew on the LCM's surface which may affect the operation of the polarizer on the LCM.

♦Response time will be extremely delay at lower temperature than the operating temperature range and on the other hand LCM may turn black at temperature above its operational range. However those phenomenon do not mean malfunction or out of order with the LCM. The LCM will revert to normal operation once the temperature returns to the recommended temperature range for normal operation.

♦Do not display the fixed pattern for a long time when using a normally black panel, as it may cause image sticking due to the LCM structure. If the screen is displayed in fixed mode, use a screen saver. It is recommended to display the fixed mode in less than 2 minutes or less.

Do not disassemble and/or re-assemble LCM module

♦The LCD modules should be stored under the storage temperature range. the recommend condition is: Temperature : 0°C~ 40°C, Relatively humidity: ≤80%, and no more than 1 year. <u>7-2 Caution Against Static Charge</u>

◆The LCM use C-MOS LSI drivers, so customers are recommended that any unused input terminal would be connected to Vdd or Vss, do not input any signals before power is turn on, and ground you body, work/assembly area, assembly equipments to protect against static electricity.

•Remove the protective film slowly, keeping the removing direction approximate 30-degree not vertical from panel surface, if possible, under ESD control device like ion blower, and the humidity of working room should be kept over 50%RH to reduce the risk of static charge.

Avoid the use work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.

♦In handling the LCM, wear non-charged material gloves. And the conducting wrist to the earth and the conducting shoes to the earth are necessary

--END--

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